

TPA6136A2 EVM

This user's guide describes the operation of the TPA6136A2 evaluation module (EVM) for the evaluation of the Texas Instruments TPA6136A2 amplifier and includes the EVM schematic, board art, and bill of materials.

Contents

1	Introduction	1
2	Introduction Operation	2
3	Reference	4
4	TPA6136A2EVM Bill of Materials	7
	List of Figures	
1	Top Assembly – X-Ray View	
2	Layer 2 – X-Ray View	6
3	Layer 3– X-Ray View	6
4	Bottom Layer – X-Ray View	
	List of Tables	
1	TPA6136A2EVM Bill of Materials	7
		- 1

1 Introduction

This section provides an overview of the Texas Instruments (TI) TPA6136A2 DirectPath™ stereo headphone amplifier evaluation module (EVM). It includes a brief description of the module and a list of EVM specifications.

1.1 Description

The TPA6136A2 is a DirectPathTM stereo headphone amplifier capable of delivering 25 mW/Ch into 16 Ω and requires no output DC blocking capacitors.

The TPA6136A2 EVM is a complete, stand-alone audio board. It contains the TPA6136A2 WCSP (YFF) DirectPath™ stereo headphone amplifier. All components are Pb-free.

1.2 EVM Specifications

Supply voltage range, V _{DD}	2.5 V to 5.5 V
Supply current, I _{DD}	0.5 A, maximum
Continuous output power, P_O , V_{DD} = 5 V, 16 Ω , THD+N = 1 %	25 mW

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Operation www.ti.com

2 Operation

This section describes how to operate the TPA6136A2EVM.

2.1 Quick-Start List for Stand-Alone Operation

Use the following steps when operating the TPA6136A2EVM stand alone or when connecting the EVM into an existing circuit.

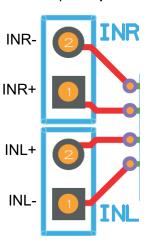
2.1.1 Power and Ground

- 1. Verify that the external power sources are set to OFF.
- 2. Set the power supply voltage between 2.5 V and 5.5 V. When connecting the power supply to the EVM, first connect the ground connection to the GND connector, and then connect the positive supply to the V_{DD} connector. Verify that the connections are made to the correct pin connector.

2.1.2 Inputs and Outputs

2.1.2.1 Audio

- 1. Verify that the audio source is set to the minimum level.
- 2. Connect the audio source to the inputs, INL and INR.
- 3. Connect INL+ and INR+ to ground for single-ended input.
- 4. Connect a headset or other load to the headphone jack.



2.1.2.2 Shutdown Controls

1. Shutdown is controlled by pushbutton S1. Press and hold S1 to place the TPA6136A2 in shutdown. Release S1 to reactivate the TPA6136A2.

2.1.3 Gain Setting

Set the gain of the TPA6136A2 at GAIN. Set GAIN = LOW for 0 dB. Set GAIN = HIGH for 6 dB.

2.1.4 HI-Z Control

Output will be in high-Z state when HI-Z = HIGH. Set HI-Z = LOW to disable the high-Z mode.



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2.1.5 Power Up

- 1. Verify the correct connections as described in Sections 2.1.1 and 2.1.2.
- 2. Verify the correct voltage setting of the power supply and turn ON the power supply. Proper operation of the EVM should begin.
- 3. Adjust the audio signal source as needed.

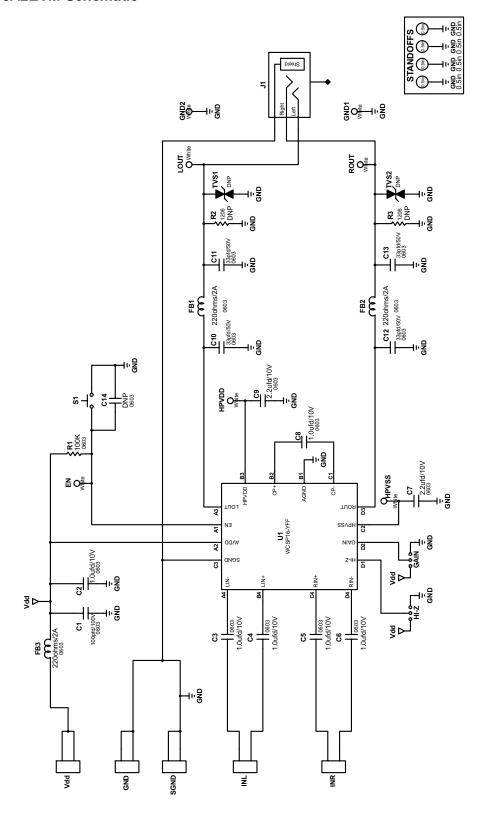


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3 Reference

This section includes the EVM schematic, board layout reference, and parts list.

3.1 TPA6136A2EVM Schematic





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3.2 TPA6136A2EVM PCB Layers

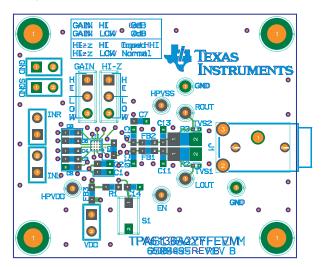


Figure 1. Top Assembly – X-Ray View

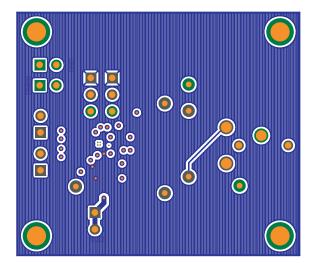


Figure 2. Layer 2 - X-Ray View



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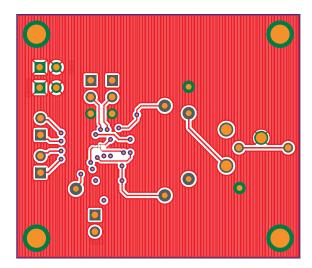


Figure 3. Layer 3- X-Ray View

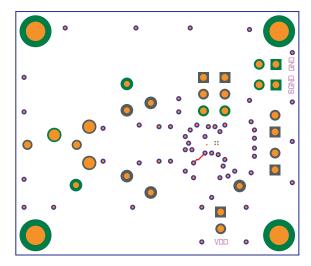


Figure 4. Bottom Layer – X-Ray View



4 TPA6136A2EVM Bill of Materials

Table 1. TPA6136A2EVM Bill of Materials

1	114				
	U1	TPA6136A2YFF	CAP-FREE STEREO HEADPHONE AMP WITH DIFFERENTIAL INPUTS ROHS	Texas Instruments	Texas Instruments
	I	SE	MICONDUCTORS	1	1
2	TVS1, TVS2	ESDALC6V1- 1BT2	TRANSIENT VOLTAGE SUPPRESSION BIDIR 6.1V 9A SOD-882 ROHS	Mouser	ST Microelectronics
	II.	ll.	CAPACITORS	1	
6	C2-C6,C8	PCC2174CT	CAP SMD0603 CERM 1.0µF 10V 10% X5R ROHS	Digi-Key	Panasonic
2	C7, C9	490-4520-1	CAP SMD0603 CERM 2.2µF 10V 10% X7R ROHS	Digi-Key	Murata
1	C1	478-1146-1	CAP SMD0603 CERM 100PFD 100V 5% COG ROHS	Digi-Key	AVX
4	C10-C13	PCC330ACVCT	CAP SMD0603 CERM 33PFD 50V 5% NPO ROHS	Digi-Key	Panasonic
	ı		RESISTORS	1	
1	R1	P100KGCT	RESISTOR SMD0603 100K Ω 5% THICK FILM 1/10W ROHS	Digi-Key	Panasonic
	ı	F	ERRITE BEADS	1	1
3	FB1-FB3	445-1565-1	FERRITE CHIP, 220 Ω 2A 100MHZ SMD 0603 ROHS	Digi-Key	TDK
	II.	HEADERS	S, JACKS AND SHUNTS	1	
5	GND, INL, INR, Vdd, SGND	S1011E-02	HEADER THRU MALE 2 PIN 100LS GOLD ROHS	Digi-Key	Sullins
1	HI-Z/GAIN	S1011E-03-ND	HEADER THRU MALE 3 PIN 100LS GOLD ROHS	Digi-Key	Sullins
1	J1	806-STX-3000	JACK, MINI-STEREO, ROHS	Mouser	Kycon
6	GND, INL, INR,Vdd, SGND, HI-Z/GAIN	S9001	SHUNT, BLACK AU FLASH 0.100 ROHS	Digi-Key	Sullins
	u.	TEST PO	DINTS AND SWITCHES	1	
7	EN, GND1, GND2, LOUT, ROUT, HPVDD, HPVSS	5002K	PC TEST POINT, WHITE, ROHS	Digi-Key	Keystone Electronics
1	S1	EG4344CT	SWITCH, MOM, 160G SMT 4×3MM ROHS	Digi-Key	E-Switch
		STANDO	FFS AND HARDWARE		
4	SO1,SO2,SO3,S O4	2027K	STANDOFF, 4-40, 0.5INx3/16IN, ALUM RND F-F	Digi-Key	Keystone Electronics
45					
	1	COMPON	ENTS NOT ASSEMBLED		
	6 2 1 4 1 3 5 1 1 6 7 7 1 4	6 C2–C6,C8 2 C7, C9 1 C1 4 C10–C13 1 R1 3 FB1–FB3 5 GND, INL, INR, Vdd, SGND 1 HI-Z/GAIN 1 J1 6 GND, INL, INR, Vdd, SGND, HI-Z/GAIN 7 EN, GND1, GND2, LOUT, ROUT, HPVDD, HPVSS 1 S1 4 SO1,SO2,SO3,S O4	6 C2-C6,C8 PCC2174CT 2 C7, C9 490-4520-1 1 C1 478-1146-1 4 C10-C13 PCC330ACVCT 1 R1 P100KGCT F3 FB1-FB3 445-1565-1 HEADERS 5 GND, INL, INR, Vdd, SGND 1 HI-Z/GAIN S1011E-02-ND 1 J1 806-STX-3000 6 GND, INL, INR, S9001 INR,Vdd, SGND, HI-Z/GAIN TEST PC 7 EN, GND1, GND2, LOUT, ROUT, HPVDD, HPVSS 1 S1 EG4344CT STANDO 4 SO1,SO2,SO3,S O4	BIDIR 6.1V 9A SOD-882 ROHS	BIDIR 6.1V 9A SOD-882 ROHS

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of HPVSS - 0.3 V to HPVDD + 0.3 V and the output voltage range of HPVSS to HPVDD.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85°C. The EVM is designed to operate properly with certain components above 85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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